

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









SCR / SCR and SCR / Diode (MAGN-A-PAK Power Modules), 230 A



PRODUCT SUMMARY						
I _{T(AV)}	230 A					
Type	Modules - thyristor, standard					
Package	MAGN-A-PAK					
Circuit configuration	Two SCRs doubler circuit, SCR / diode doubler circuit, positive control, SCR / diode doubler circuit, negative control, two SCRs common cathodes, two SCRs common anodes					

FEATURES

- · High voltage
- · Electrically isolated base plate
- 3500 V_{RMS} isolating voltage
- · Industrial standard package
- · Simplified mechanical designs, rapid assembly
- · High surge capability
- Large creepage distances
- UL approved file E78996
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

DESCRIPTION

This VSK series of MAGN-A-PAK modules uses high voltage power thyristor / thyristor and thyristor / diode in seven basic configurations. The semiconductors are electrically isolated from the metal base, allowing common heatsinks and compact assemblies to be built. They can be interconnected to form single phase or three phase bridges or as AC-switches when modules are connected in anti-parallel mode. These modules are intended for general purpose applications such as battery chargers, welders, motor drives, UPS, etc.

MAJOR RATINGS AND CHARACTERISTICS							
SYMBOL	CHARACTERISTICS	CHARACTERISTICS VALUES					
I _{T(AV)}	85 °C	230					
I _{T(RMS)}		510	A				
I _{TSM}	50 Hz	7500	A				
	60 Hz	7850					
l ² t	50 Hz	280	kA ² s				
1-1	60 Hz	260	KA-S				
l ² √t		280	kA ² √s				
V _{DRM} /V _{RRM}		800 to 2000	V				
T _J	Range	-40 to 130	°C				

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V _{RRM} /V _{DRM} , MAXIMUM REPETITIVE PEAK REVERSE AND OFF-STATE BLOCKING VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} /I _{DRM} AT 130 °C MAXIMUM mA				
	08	800	900					
	12	1200	1300					
VS-VSK.230-	16	1600	1700	50				
	18	1800	1900					
	20	2000	2100					

Revision: 27-Apr-17 **1** Document Number: 93053



ON-STATE CONDUCTION						
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS
Maximum average on-state current	I _{T(AV)}	180° conduction	on, half sine wave		230	Α
at case temperature	, ,	100 Conduction	on, nan sine wave		85	°C
Maximum RMS on-state current	I _{T(RMS)}	As AC switch			510	
		t = 10 ms	No voltage		7500	
Maximum peak, one-cycle on-state		t = 8.3 ms	reapplied		7850	Α
non-repetitive, surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}	Sinusoidal	6300	kA ² s
		t = 8.3 ms	reapplied	half wave,	6600	
Maximum I ² t for fusing		t = 10 ms	No voltage	initial	280	
	l ² t	t = 8.3 ms	reapplied	$T_J = T_J \text{ maximum}$	256	
		t = 10 ms	100 % V _{RRM}		198	
		t = 8.3 ms	reapplied		181	
Maximum I ² √t for fusing	I²√t	t = 0.1 ms to 1	0 ms, no voltage	reapplied	2800	kA²√s
Low level value or threshold voltage	V _{T(TO)1}	(16.7 % x π x l-	$T_{(AV)} < I < \pi \times I_{T(AV)}$), $T_J = T_J$ maximum	1.03	V
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)}), T$	$T_J = T_J \text{ maximum}$		1.07	V
Low level value on-state slope resistance	r _{t1}	(16.7 % x π x l-	$T_{(AV)} < I < \pi \times I_{T(AV)}$), $T_J = T_J$ maximum	0.77	mΩ
High level value on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T$	$T_J = T_J \text{ maximum}$		0.73	11122
Maximum on-state voltage drop	V _{TM}	$I_{TM} = \pi \times I_{T(AV)}$, $T_J = T_J$ maximum, 180° conduction, average power = $V_{T(TO)} \times I_{T(AV)} + r_f \times (I_{T(RMS)})^2$			1.59	V
Maximum holding current	I _H	Anode supply	= 12 V, initial I_T =	30 A, T _J = 25 °C	500	
Maximum latching current	ΙL		v = 12 V, resis V, 100 μs, T _J = 25	stive load = 1 Ω , 5 °C	1000	mA

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Typical delay time	t _d	$T_J = 25$ °C, gate current = 1 A $dI_a/dt = 1$ A/ μ s,	1.0	
Typical rise time	t _r	$V_{d} = 0.67 \% V_{DRM}$	2.0	us
Typical turn-off time	t _q	I_{TM} = 300 A; dl/dt = 15 A/ μ s; T $_J$ = T $_J$ maximum; V $_R$ = 50 V; dV/dt = 20 V/ μ s; gate 0 V, 100 Ω	50 to 150	μο

BLOCKING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum peak reverse and off-state leakage current	I _{RRM,} I _{DRM}	$T_J = T_J$ maximum	50	mA
RMS insulation voltage	V _{INS}	50 Hz, circuit to base, all terminals shorted, 25 °C, 1 s	3000	V
Critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum, exponential to 67 % rated V_{DRM}	1000	V/µs

TRIGGERING					
PARAMETER	SYMBOL	TEST	CONDITIONS	VALUES	UNITS
Maximum peak gate power	P _{GM}	$t_p \le 5 \text{ ms}, T_J = T_J \text{ max}$	kimum	10.0	W
Maximum average gate power	P _{G(AV)}	$f = 50 \text{ Hz}, T_J = T_J \text{ max}$	kimum	2.0	VV
Maximum peak gate current	+ I _{GM}	$t_p \le 5 \text{ ms}, T_J = T_J \text{ max}$	kimum	3.0	Α
Maximum peak negative gate voltage	- V _{GT}	$t_p \le 5 \text{ ms}, T_J = T_J \text{ max}$	kimum	5.0	
		T _J = -40 °C	Assistant dov	4.0	V
Maximum required DC gate voltage to trigger	V _{GT}	T _J = 25 °C	Anode supply = 12 V, resistive load; Ra = 1 Ω	3.0	
		$T_J = T_J$ maximum	10000170 1000, 110 = 1 11	2.0	
		T _J = - 40 °C	Assistant dov	350	
Maximum required DC gate current to trigger	I _{GT}	T _J = 25 °C	Anode supply = 12 V, resistive load; Ra = 1 Ω	200	mA
		$T_J = T_J$ maximum	10000110000, 110 = 1 22	100	
Maximum gate voltage that will not trigger	V_{GD}	$T_J = T_J$ maximum, rated V_{DRM} applied		0.25	V
Maximum gate current that will not trigger	I_{GD}	$T_J = T_J$ maximum, rated V_{DRM} applied		10.0	mA
Maximum rate of rise of turned-on current	dl/dt	$T_J = T_J$ maximum, I_{TM}	= 400 A, rated V _{DRM} applied	500	A/µs



THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Junction operating	Junction operating temperature range			-40 to 130	°C		
Storage temperat	ture range	T _{Stg}		-40 to 150	C		
Maximum thermal resistance, junction to case per junction		R _{thJC}	DC operation	0.125	K/W		
	Typical thermal resistance, case to heatsink per module		Mounting surface flat, smooth, and greased	0.02	R⁄ VV		
Mounting	MAGN-A-PAK to heatsink		A mounting compound is recommended and the torque should be rechecked after a period	4 to 6	Nm		
torque ± 10 % busbar to MAGN-A-PAK			of about 3 h to allow for the spread of the compound.	4 10 0	INIII		
Approximate weight				500	g		
Approximate weigh	grit			17.8	oz.		
Case style				MAGN-A	-PAK		

△R CONDUCTION PER JUNCTION											
DEVICES	SINUS	SINUSOIDAL CONDUCTION AT T _J MAXIMUM					RECTANGULAR CONDUCTION AT T _J MAXIMUM				UNITS
DEVICES	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	UNITS
VSK.230-	0.009	0.010	0.010	0.020	0.032	0.007	0.011	0.015	0.020	0.033	K/W

Note

Table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

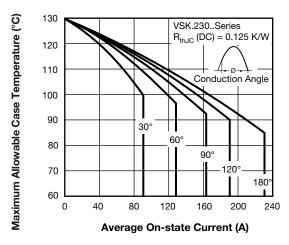


Fig. 1 - Current Ratings Characteristics

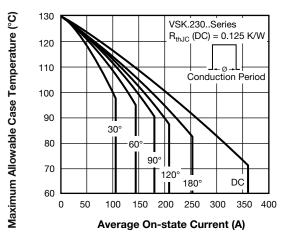


Fig. 2 - Current Ratings Characteristics

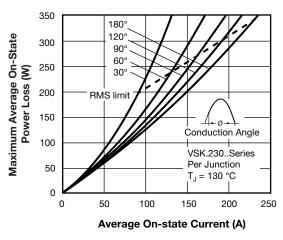


Fig. 3 - On-State Power Loss Characteristics

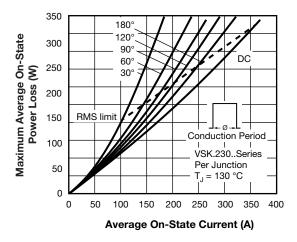


Fig. 4 - On-State Power Loss Characteristics

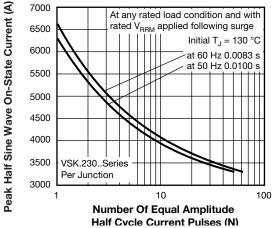


Fig. 5 - Maximum Non-Repetitive Surge Current

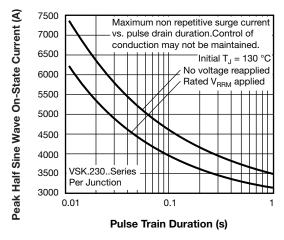


Fig. 6 - Maximum Non-Repetitive Surge Current

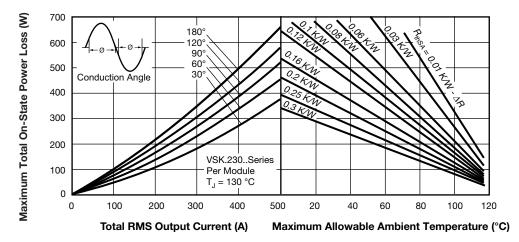


Fig. 7 - On-State Power Loss Characteristics



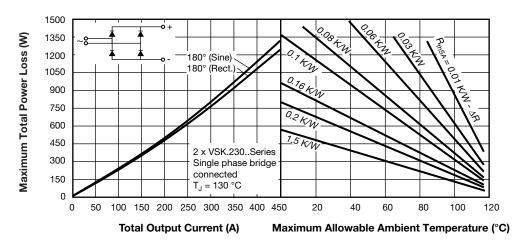


Fig. 8 - On-State Power Loss Characteristics

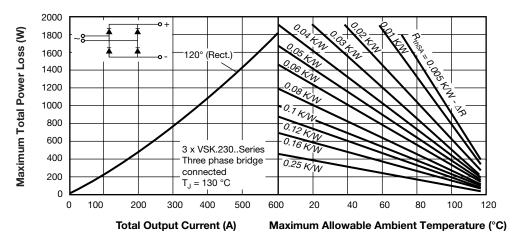


Fig. 9 - On-State Power Loss Characteristics

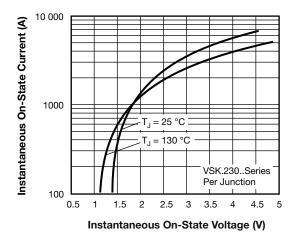


Fig. 10 - On-State Voltage Drop Characteristics

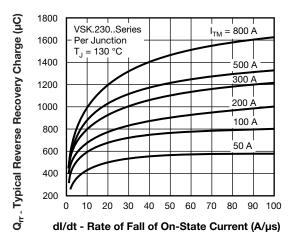


Fig. 11 - Reverse Recovery Charge Characteristics

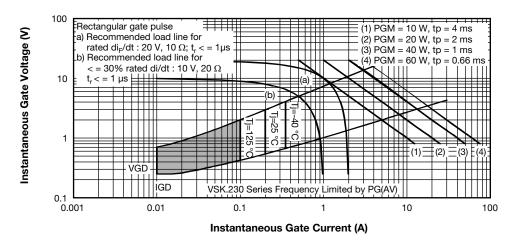


Fig. 12 - Gate Characteristics

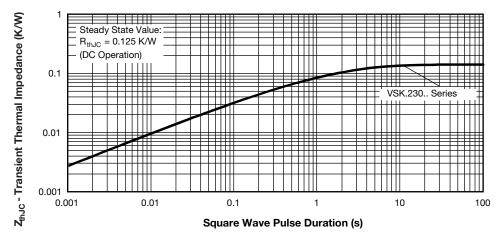
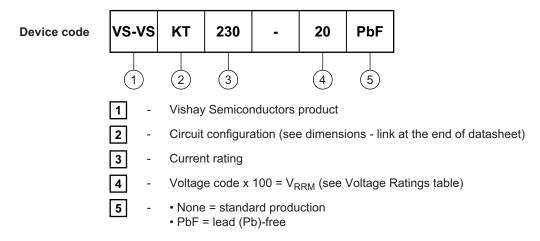


Fig. 13 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE



Note

• To order the optional hardware go to www.vishay.com/doc?95172



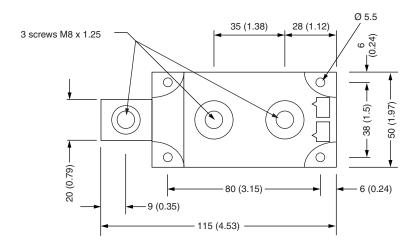
CIRCUIT CONFIGURATION		
CIRCUIT DESCRIPTION	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING
Two SCRs doubler circuit	KT	VSKT VSKT VSKT VSKT Available 800 V: contact factory for different requirements
SCR / diode doubler circuit, positive control	КН	VSKH VSKH VSKH Available 800 V: contact factory for different requirements
SCR / diode doubler circuit, negative control	KL	VSKL VSKL Available 800 V: contact factory for different requirements
Two SCRs common cathodes	кк	VSKK VSKK VSKK Available 800 V: contact factory for different requirements
Two SCRs common anodes	KV	VSKV VSKV VSKV Available 800 V: contact factory for different requirements

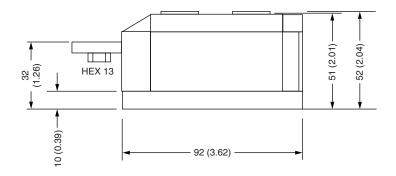
LINKS TO RELAT	TED DOCUMENTS
Dimensions	www.vishay.com/doc?95086



MAGN-A-PAK

DIMENSIONS in millimeters (inches)





Notes

- Dimensions are nominal
- Full engineering drawings are available on request
- UL identification number for gate and cathode wire: UL 1385
- UL identification number for package: UL 94 V-0



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.